

DESIGN NOTES

Dual DC/DC Controller for DDR Power with Differential V_{DDQ} Sensing and $\pm 50\text{mA}$ V_{TT} Reference

Design Note 503

Ding Li

Introduction

The LTC[®]3876 is a complete DDR power solution, compatible with DDR1, DDR2, DDR3 and DDR4 lower voltage standards. The IC includes V_{DDQ} and V_{TT} DC/DC controllers and a precision linear V_{TT} reference. A differential output sense amplifier and precision internal reference combine to offer an accurate V_{DDQ} supply. The V_{TT} controller tracks the precision VTTR linear reference with less than 20mV total error. The precision VTTR reference maintains 1.2% regulation accuracy, tracking one-half V_{DDQ} over temperature for a $\pm 50\text{mA}$ reference load.

The LTC3876 features controlled on-time, valley current mode control, allowing it to accept a wide 4.5V to 38V input range, while supporting V_{DDQ} outputs from 1.0V to 2.5V, and V_{TT} and VTTR outputs from 0.5V to 1.25V. Its phase-locked loop (PLL) can be synchronized to an external clock between 200kHz and 2MHz. It also features voltage-tracking soft-start, PGOOD and fault protection.

High Efficiency, 4.5V to 14V Input, Dual Output DDR Power Supply

Figure 1 shows a DDR3 power supply that operates from a 4.5V to 14V input. Figure 2 shows efficiency curves for discontinuous and forced continuous modes of operation.

Load-Release Transient Detection

As output voltages drop, a major challenge for switching regulators is to limit the overshoot in V_{OUT} during a load-release transient. The LTC3876 uses the DTR pin to monitor the first derivative of the ITH voltage to detect load release transients. Figure 3 shows how this pin is used for transient detection.

The two R_{ITH} resistors establish a voltage divider from $INTV_{CC}$ to SGND, and bias the DC voltage on the DTR pin (at steady-state load or ITH voltage) slightly above half of $INTV_{CC}$. For a given C_{ITH1} , this divider does not

LT, LTC, LTM, Linear Technology, the Linear logo and OPTI-LOOP are registered trademarks of Linear Technology Corporation. All other trademarks are the property of their respective owners.

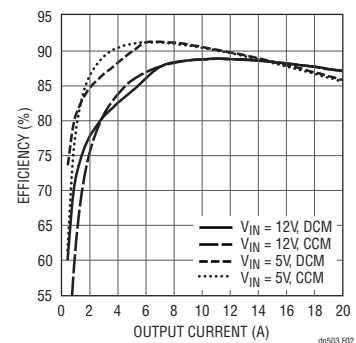
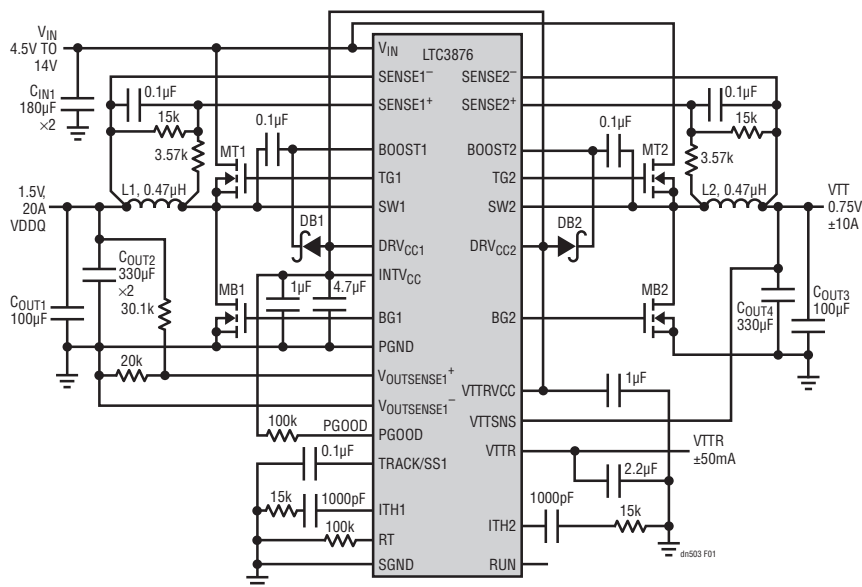


Figure 2. Efficiency of Circuit in Figure 1 ($V_{DDQ} = 1.5\text{V}$, $f_{sw} = 400\text{kHz}$, $L = 470\text{nH}$)

Figure 1. 1.5V $V_{DDQ}/20\text{A}$ 0.75V $V_{TT}/10\text{A}$ DDR3 Power Supply

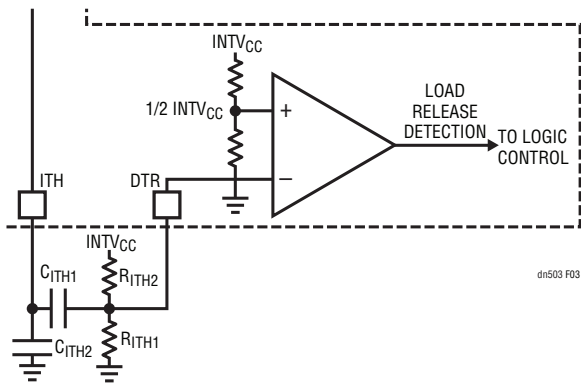


Figure 3. Functional Diagram of DTR Connection for Load Transient Detection

change compensation performance as long as R_{ITH1}/R_{ITH2} equals R_{ITH} that would normally be used in conventional single-resistor OPTI-LOOP[®] compensation.

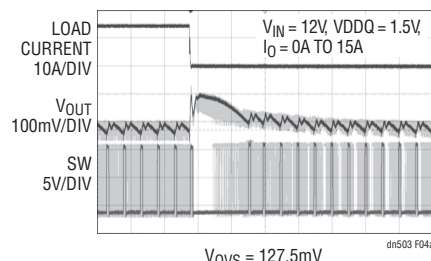
The divider sets the RC time constant needed for the DTR duration. The DTR sensitivity can be adjusted by the DC bias voltage difference between DTR and half $INTV_{CC}$. This difference could be set as low as 100mV, as long as the ITH ripple voltage with DC load current does not trigger the DTR. If the load transient is fast enough that the DTR voltage drops below half of $INTV_{CC}$, a load release event is detected. The bottom gate (BG) is turned off, so that the inductor current flows through the body diode in the bottom MOSFET.

Note that the DTR feature causes additional losses on the bottom MOSFET, due to its body diode conduction. The bottom FET temperature may be higher with a load of frequent and large load steps—an important design consideration. Test results show a 20°C increase when a continuous 100%-to-50% load step pulse chain with 50% duty cycle and 100kHz frequency is applied to the output.

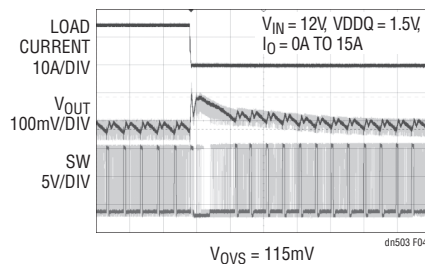
V_{TT} Reference (VTTR)

The linear V_{TT} reference, VTTR, is specifically designed for large DDR memory systems by providing superior accuracy and load regulation for up to $\pm 50\text{mA}$ output load. VTTR is the buffered output of the V_{TT} differential reference resistor divider. VTTR is a high output linear reference, which tracks the V_{TT} differential reference resistor divider and equals half of the remote-sense V_{DDQ} voltage.

Connect VTTR directly to the DDR memory VREF input. Both input and output supply decoupling are important to performance and accuracy. A 2.2 μF output capaci-



a. LTC3876 DTR Disabled



b. LTC3876 DTR Enabled

Figure 4. Load Release Comparison

tor is recommended for most typical applications. It is suggested to use no less than 1 μF and no more than 47 μF on the VTTR output. The VTTR power comes from the VTTRVCC pin. The typical recommended input VTTRVCC RC decoupling filter is 2.2 μF and 1 Ω . When $V_{DDQ\text{SNS}}$ is tied to $INTV_{CC}$, the VTTR linear reference output is 3-stated and VTTR becomes a reference input pin, with voltage from another LTC3876 in a multiphase application.

V_{TT} Supply

The V_{TT} supply reference is connected internally to the output of the VTTR V_{TT} reference output. The V_{TT} supply operates in forced continuous mode and tracks V_{DDQ} in start-up and in normal operation regardless of the MODE/PLLIN settings. In start-up, the V_{TT} supply is enabled coincident with the V_{DDQ} supply. Operating the V_{TT} supply in forced continuous mode allows accurate tracking in start-up and under all operating conditions.

Conclusion

The LTC3876 is a complete high efficiency and high accuracy solution for DDR memory power supplies. The unique controlled on-time architecture allows extremely low step-down ratios while maintaining a fast, constant switching frequency. The wide input voltage range of 4.5V–38V and programmable, synchronizable switching frequency from 200kHz to 2MHz gives designers the flexibility needed to optimize their systems.

Data Sheet Download

www.linear.com

For applications help,
call (408) 432-1900, Ext. 3598